

OVERVIEW

The SM8220/SM8221 Calling Number Identification Receiver IC is a CMOS integrated circuit, which provides an interface to various calling information delivery services such as Calling Number Delivery (CND) and Calling Name Delivery (CNAM) compatible with the Bellcore GR-30-CORE. The device also contains a power down circuit, a ring detect circuit and a carrier detect circuit for easier system implementation.

FEATURES

- •Compatible with Bellcore GR-30-CORE
- •Integrated band pass filter
- •FSK demodulator Bell 202 and ITU-T V.23
- •High input sensitivity: -48 dBm typical
- •Ring detect output
- •Carrier Detect Output (SM8220)
- •Power down mode: 1µA power down current

- •Uses 3.579545 MHz crystal (SM8220) or external clock source
- •Power supply voltage: 3V to 5.5V
- •Low power consumption
- Molybdenum-gate CMOS process
- Package

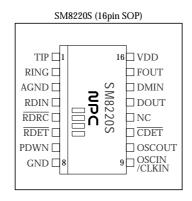
SM8220: 16 pin SOP, 16 pin DIP SM8221: 8 pin SOP, 8 pin DIP

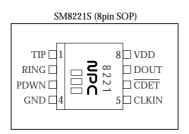
APPLICATIONS

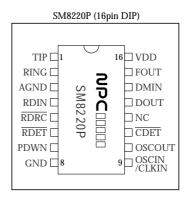
- •Calling Number Delivery service
- Adjunct Boxes
- •Telephone Answering Machines

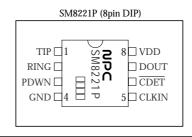
- •Feature Phones
- Fax Machines
- •Computer Interface Products

PINOUT(Top View)

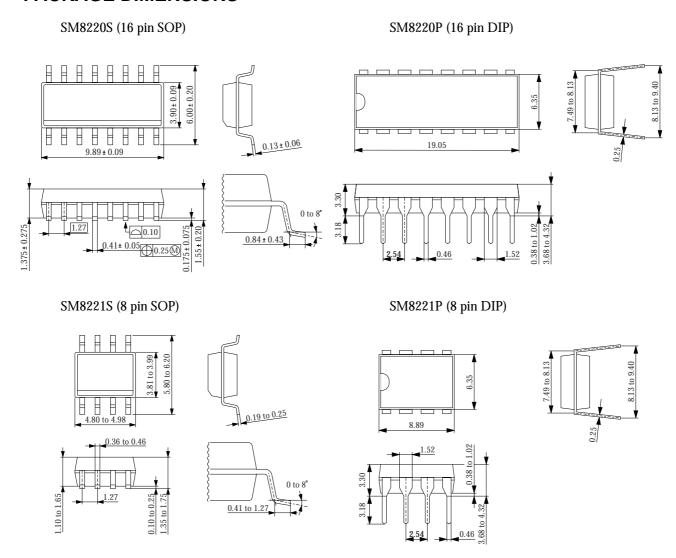




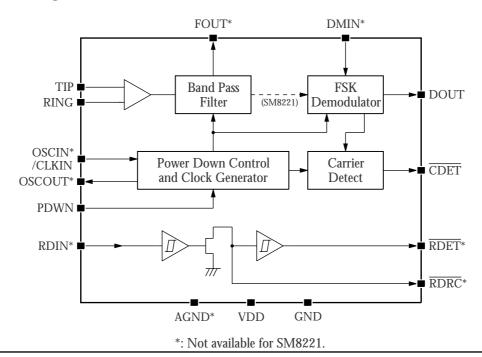




PACKAGE DIMENSIONS (Unit: mm)



BLOCK DIAGRAM



PIN DESCRIPTIONS

Number		Name	i/o	Function	
SM8220	SM8221				
1	1	TIP	i	Tip Input: This pin is connected to the tip side of the twisted pair telephone wires.	
				This pin must be DC isolated from the phone line.	
2	2	RING	i	Ring Input: This pin is connected to the ring side of the twisted pair telephone wires.	
				This pin must be DC isolated from the phone line.	
3	-	AGND	0	Analog Ground: 1/2 VDD voltage output. This pin must be grounded through 0.1 μF capacitor.	
4	-	RDIN	si	Ring Detect Input: The attenuated ring signal is connected to this pin for the ring detection.	
5	-	RDRC	od	Ring Detect RC Terminal: An RC network will be connected to this pin to set time delays for	
				the ring signal detection.	
6	-	RDET	0	Ring Detect Output: This pin is an output of a schmitt trigger buffer which input is connected	
				to RDRC pin. The low level at this pin indicates that the ring signal is detected.	
7	3	PDWN	si	Power Down Control: This pin must be kept at low level for the normal operation.	
				When it is high, the device will be in the power down.	
				Under the power down mode, OSCOUT, $\overline{\text{CDET}}$ and DOUT pins are set to high level and	
				AGND, FOUT pins are set to high impedance.	
8	4	GND	-	Device Ground: This pin is connected to the system ground.	
9	5	OSCIN	i	Crystal Oscillator Input: A crystal will be connected between this pin and OSCOUT pin.	
		/CLKIN		This pin may be driven from an external clock source.	
10	-	OSCOUT	0	Crystal Oscillator Output: A crystal will be connected between this pin and OSCIN pin.	
				This pin must be kept open when OSCIN pin is driven from an external clock source.	
11	6	CDET	0	Carrier Detect Output: When low, this output indicates that a valid carrier present on the line.	
12	-	NC	-	No connection pin.	
13	7	DOUT	0	Data Out : This pin presents the output of the demodulator while $\overline{\text{CDET}}$ pin is low.	
				When CDET pin goes high, this pin is held high.	
14	-	DMIN	i	Demodulator Input: This pin is connected from FOUT pin through a 0.1µF capacitor.	
				No other components should be connected to this pin.	
15	-	FOUT	0	Band Pass Filter Output: This pin is connected to DMIN pin through a 0.1µF capacitor.	
				No other components should be connected to this pin.	
16	8	VDD	-	Power Supply: Positive power supply pin.	

(Note) si: Schmitt Triger Input, od: Open Drain Output.

ABSOLUTE MAXIMUM RATINGS

(GND= 0V unless otherwise noted)

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Parameter	Symbol	Condition	Rating	Unit		
Supply Voltage	Vdd		-0.5 to 7.0	V		
Input Voltage	V_{IN}		−0.3 to Vdd+0.3	V		
Input Current	Iin		±10	mA		
Power Dissipation	PD		120	mW		
Operating Temperature Range	Ta		−20 to 85	°C		
Storage Temperature Range	Tstg		-40 to 125	°C		
Soldering Temperature	Tsld		255	°C		
Soldering Time	tsld		10	sec		

ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS

(VDD= 5 ± 0.5 V, GND = 0 V, fclk = 3.579545 MHz, Ta = -20 to 85 °C unless otherwise noted)

	Rating					
Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
DC Supply Voltage	Vdd		3	5	5.5	V
Supply Current	Idd	*1		1.7	3	mA
Power Down Current	Idpd	*2			1	μΑ
Input Low Voltage1	V _{IL1}	OSCIN/CLKIN pin			0.3Vdd	V
		Voscout= 0.8Vdd				
Input High Voltage1	VIH1	OSCIN/CLKIN pin	0.7Vdd			V
		Voscout= 0.2Vdd				
Input Low Voltage2	VIL2	PDWN, RDIN, RDRC pin		2	0.3Vdd	V
Input High Voltage2	V _{IH2}	PDWN, RDIN, RDRC pin	0.75Vdd	3		V
Output Low Voltage	Vol	DOUT, RDET, CDET, RDRC			0.4	V
		pin, Vdd= 4.5V, Iol= 1.6mA				
Output High Voltage	Vон	DOUT, RDET, CDET pin	3.7			V
		VDD= 4.5V, IOH= -1.6mA				
Input Leakage Current	IIN	OSCIN/CLKIN, PDWN, RDIN	-1		1	μΑ
		pin, V_{DD} = 5.5 V , V_{IN} = 0 or 5 V				
Output Leakage Current	Ioff	RDRC pin, RDIN= 0V			1	μΑ
		VDD= 5.5V,VOH= 5.5V				
Input DC Resistance	Rin	TIP, RING pin, Vdd= 5V	175	250	325	$k\Omega$
		Impedance measured from 1/2VDD				

^{*1:} OSCIN/CLKIN= 0V, PDWN= 0V, RDIN= 0V, \overline{RDRC} = 0V, Other Input Pins= open

^{*2:} OSCIN/CLKIN= 0V, PDWN= VDD, RDIN= 0V, RDRC= 0V, Other Input Pins= open

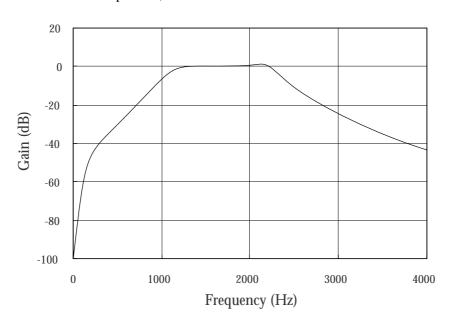
AC CHARACTERISTICS

(V_{DD} = 5.0V, GND= 0V, f_{CLK} = 3.579545MHz, T_{a} = -20 to 85 °C, 0dBm= 0.7746Vrms @ 600Ω unless otherwise noted)

				Rating		
Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
Input Sensitivity		TIP, RING pin		-48		dBm
TIP, RING pin		V _{DD} = 5V			-15	dBm
Input Level		V _{DD} = 3V			-18	
Band Pass Filter Frequency Response		60Hz		-80		dB
(relative to 1700 Hz @ –34 dBm		1200 Hz		-1		
input level)		2200Hz		0		
		4000Hz		-43		
		≥10000Hz		-54		
Carrier Detect ON Sensitivity	CDon	CDET pin		-48	-44	dBm
Carrier Detect OFF Sensitivity	CDoff	CDET pin	-55	-51		dBm
Oscillator Frequency	fclk		-0.1%	3.579545	+0.1%	MHz

TYPICAL BAND-PASS FILTER FREQUENCY RESPONSE

(Relative to 1700 Hz @ -34 dBm input level)



SWITCHING CHARACTERISTICS

(Vdd= 5.0V, GND= 0V, fclk= 3.579545MHz, Ta= 25 °C, Cl= 50pF unless otherwise noted)

				Rating		
Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
Power Down Low to	t dosc			5		ms
Oscillator Start Up						
Power Down Low to	t supd			10		ms
FSK Data Detect						
Carrier Detect Acquisition Time	$t_{ m DAQ}$			10		ms
End of Data to Carrier Detect High	$t_{ extsf{DCH}}$			10		ms

FUNCTIONAL DESCRIPTION

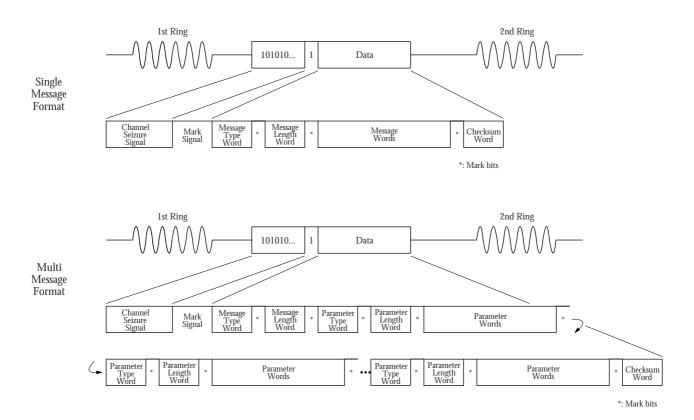
The SM8220/SM8221 Calling Number Identification Receiver IC is a device compatible with the Bellcore GR-30-CORE for transmitting asynchronous voice-band data to Customer Premises Equipment (CPE) from a serving Stored Program Controlled Switching System (SPCS) or a Central Office (CO). This data transmission technique is

applicable in a variety of services such as Calling Number Delivery (CND), Calling Name Delivery (CNAM). With these services, a subscriber will have the ability to display a message containing the phone number of the calling party, the name of a calling party, the date and the time.

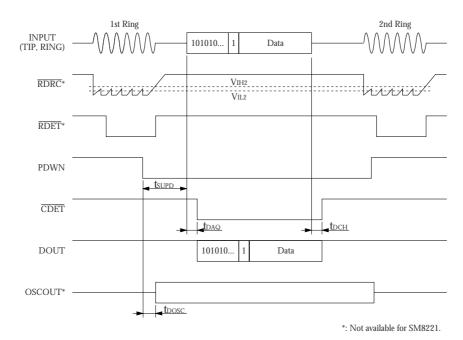
The data signaling interface should conform to Bell 202 and ITU-T V.23 specification, which is:

	Bell 202	ITU-T V.23	
Modulation Type	Continuous - phase binary frequency shift keying (FSK)		
Logical 1 (Mark)	1200 ± 12Hz	1300 ± 22 Hz	
Logical 0 (Space)	2200 ± 22Hz	2100 ± 22 Hz	
Carrier Frequency	1700Hz	1700Hz	
Transmission rate	1200BPS	1200BPS	
Data format	serial, asynchronous	serial, asynchronous	

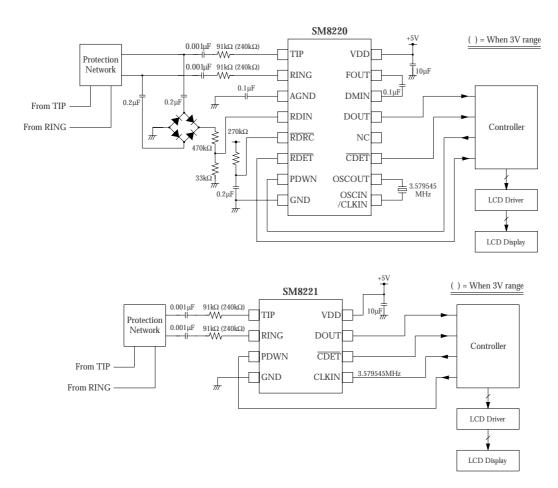
Bellcore GR-30-CORE Data Format



TIMING DIAGRAM



TYPICAL APPLICATION CIRCUIT



(Note)

When the Ring Detect feature of SM8220 is not used, always connect RDIN and RDRC pins to the system ground level.

This will cut excess current drain from VDD under the normal and power down mode of operation.

This diagram example is desingned to adapt to the specifications of $\dot{\mathbf{U}}$ nited States.

When it is used in other area, the constants may have to chenged appropriately.

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